

JOURNAL OF ALLOYS AND COMPOUNDS

(Formerly Journal of the Less-Common Metals)

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Publication information: *Journal of Alloys and Compounds* (ISSN 0925- 8388). For 2011, volume 509 is scheduled for publication by Elsevier (Radarweg 29, 1043 NX Amsterdam, the Netherlands). Further information on this journal is available from the Publisher or from the Elsevier Customer Service Department nearest you or from this journal's website (<http://www.elsevier.com/locate/jallcom>). Information on other Elsevier products is available through Elsevier's website (<http://www.elsevier.com>). Periodicals Postage Paid at Rahway, NJ, and at additional mailing offices.

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USA mailing notice: *Journal of Alloys and Compounds* (ISSN 0925-8388) is published semimonthly by Elsevier B.V. (Radarweg 29, 1043 NX Amsterdam, The Netherlands). Periodical postage paid at Rahway NJ and additional mailing offices.

USA POSTMASTER: Send change of address to *Journal of Alloys and Compounds*, Elsevier Customer Service Department, 3251 Riverport Lane, Maryland Heights, MO 63043, USA.

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